



General Description

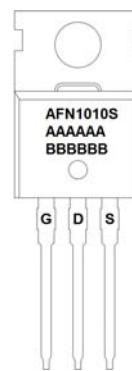
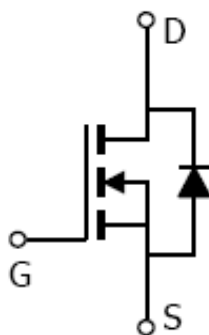
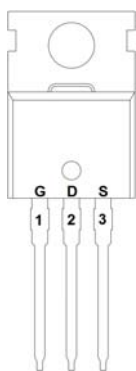
AFN1010S, N-Channel enhancement mode MOSFET, uses Advanced Trench Technology to provide excellent $R_{DS(ON)}$, low gate charge.

These devices are particularly suited for low voltage power management, and low in-line power loss are needed in commercial industrial applications.

Features

- 100V/15A, $R_{DS(ON)} = 9m\Omega @ V_{GS}=10V$
- 100V/10A, $R_{DS(ON)} = 13m\Omega @ V_{GS}=4.5V$
- Super high density cell design for low $R_{DS(ON)}$
- TO-220-3L package design

Pin Description (TO-220-3L)



Application

- Power Supply - Secondary Synchronous Rectification
- DC/DC converter
- DC/AV inverter
- Power tools
- Motor drive switch

Pin Define

Pin	Symbol	Description
1	G	Gate
2	D	Drain
3	S	Source

Ordering Information

Part Ordering No.	Part Marking	Package	Unit	Quantity
AFN1010ST220TG	AFN1010S AAAAAA BBBBBB	TO-220-3L	Tube	50 EA

※ A Lot code

※ B Date code

※ AFN1010ST220TG : Tube ; Pb- Free ; Halogen –Free



Absolute Maximum Ratings

(T_A=25°C Unless otherwise noted)

Parameter	Symbol	Typical	Unit
Drain-Source Voltage	V _{DSS}	100	V
Gate –Source Voltage	V _{GSS}	±20	V
Continuous Drain Current(T _J =150°C)	I _D	T _c =25°C 80	A
		T _c =70°C 40	
Pulsed Drain Current	I _{DM}	135	
Single Pulse Avalanche Current	I _{AS}	40	
Single Avalanche Energy	E _{AS}	80	mJ
Power Dissipation	P _D	125	W
Operating Junction Temperature	T _J	150	°C
Storage Temperature Range	T _{STG}	-55/150	°C
Thermal Resistance-Junction to Ambient	R _{θJA}	40	°C/W
Thermal Resistance-Junction to Case	R _{θJC}	1.2	

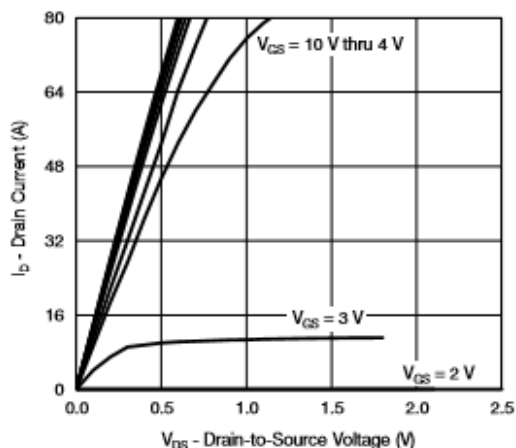
Electrical Characteristics

(T_A=25°C Unless otherwise noted)

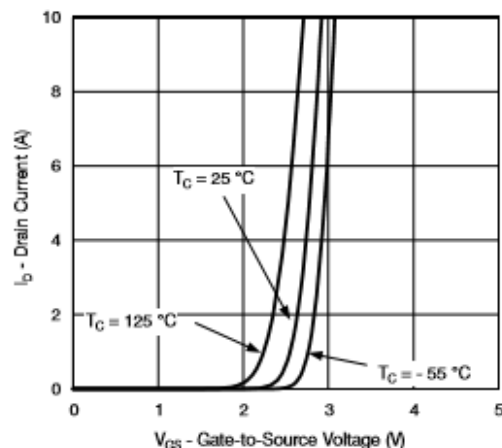
Parameter	Symbol	Conditions	Min.	Typ	Max.	Unit
Static						
Drain-Source Breakdown Voltage	V _{(BR)DSS}	V _{GS} =0V, I _D =250uA	100			V
Gate Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =250uA	1.2		2.5	
Gate Leakage Current	I _{GSS}	V _{DS} =0V, V _{GS} =±20V			±100	nA
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =80V, V _{GS} =0V			1	uA
		V _{DS} =80V, V _{GS} =0V T _J =85°C			10	
On-State Drain Current	I _{D(on)}	V _{DS} ≥5V, V _{GS} =10V	30			A
Drain-Source On-Resistance	R _{DS(on)}	V _{GS} =10V, I _D =15A		8	9	mΩ
		V _{GS} =4.5V, I _D =10A		11.5	13	
Forward Transconductance	g _{FS}	V _{DS} =10V, I _D =20A		60		S
Diode Forward Voltage	V _{SD}	I _S =5A, V _{GS} =0V		0.8	1.3	V
Dynamic						
Total Gate Charge	Q _g	V _{DS} =50V, V _{GS} =4.5V I _D ≡10A		20	40	nC
Gate-Source Charge	Q _{gs}			6		
Gate-Drain Charge	Q _{gd}			9		
Input Capacitance	C _{iss}	V _{DS} =50V, V _{GS} =0V f=1MHz		2050		pF
Output Capacitance	C _{oss}			825		
Reverse Transfer Capacitance	C _{rss}			60		
Turn-On Time	t _{d(on)}	V _{DD} =50V, R _L =5Ω I _D ≡10A, V _{GEN} =10V R _G =1Ω		12	25	ns
	t _r			10	20	
Turn-Off Time	t _{d(off)}			35	70	
	t _f			10	20	



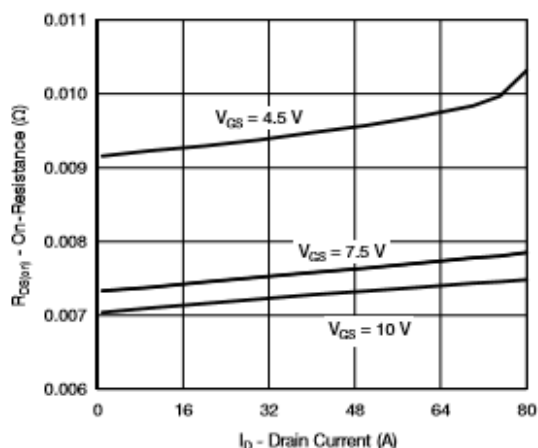
Typical Characteristics



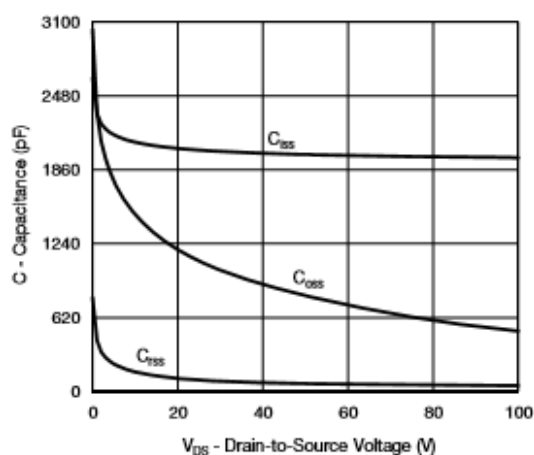
Output Characteristics



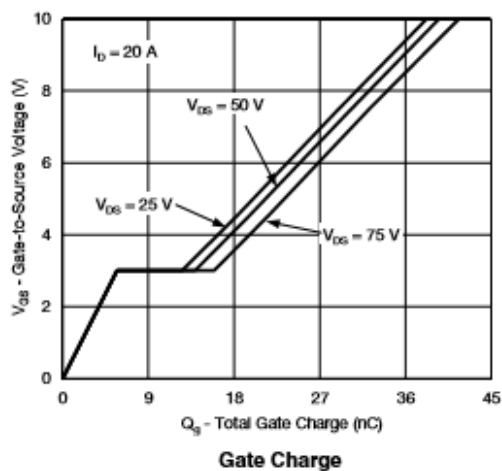
Transfer Characteristics



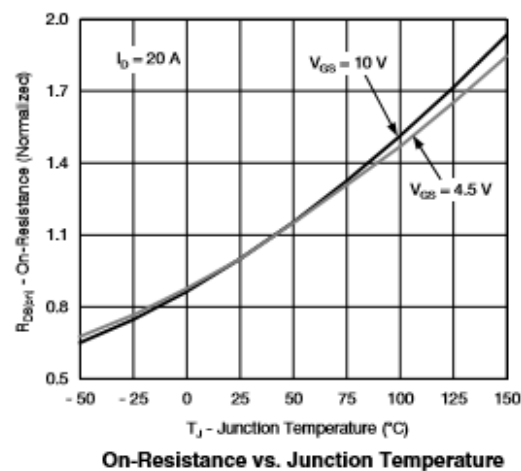
On-Resistance vs. Drain Current and Gate Voltage



Capacitance



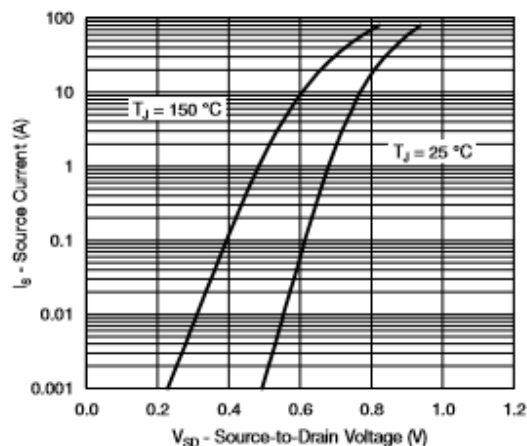
Gate Charge



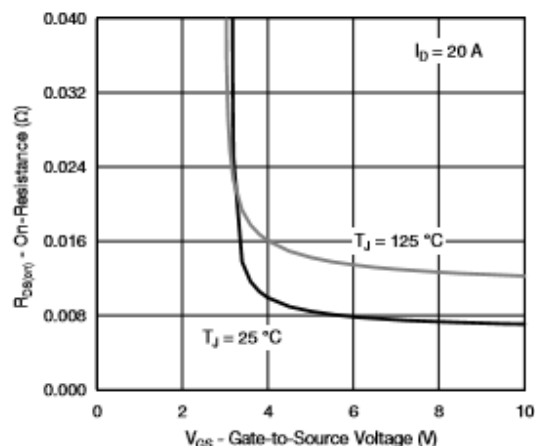
On-Resistance vs. Junction Temperature



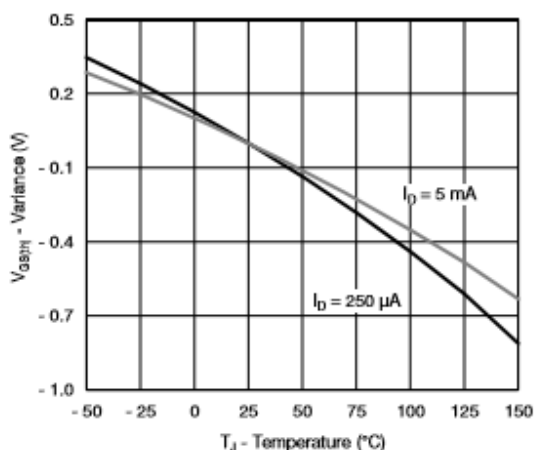
Typical Characteristics



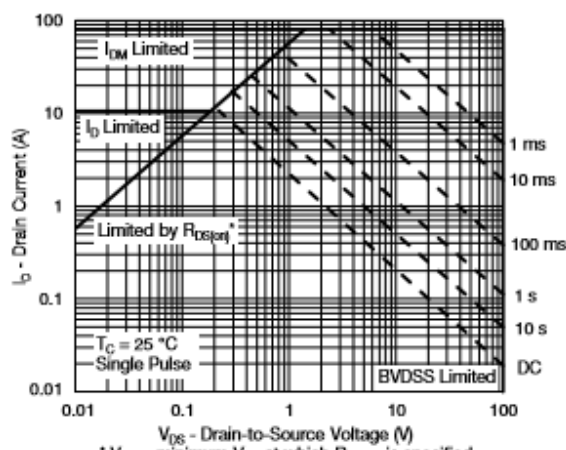
Source-Drain Diode Forward Voltage



On-Resistance vs. Gate-to-Source Voltage

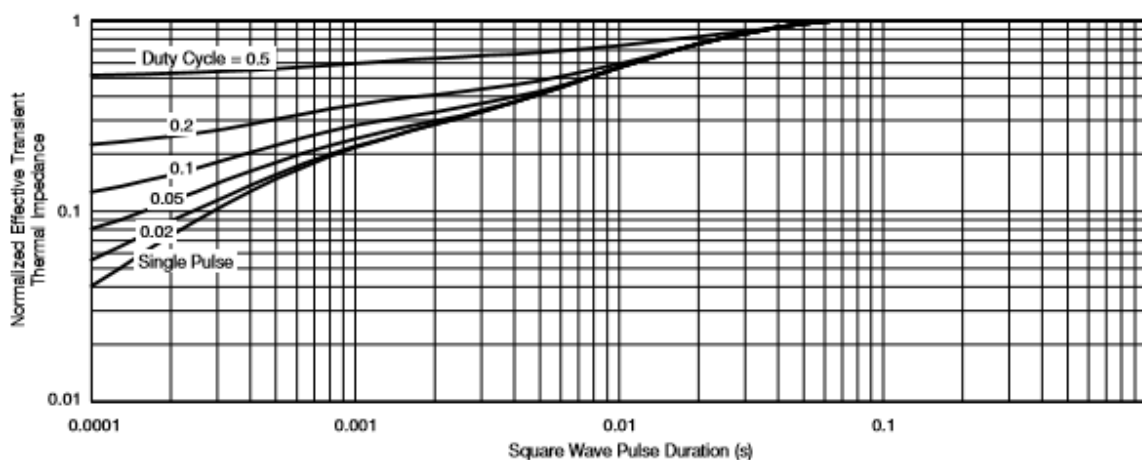


Threshold Voltage



* $V_{GS} >$ minimum V_{GS} at which $R_{DS(on)}$ is specified

Safe Operating Area, Junction-to-Ambient

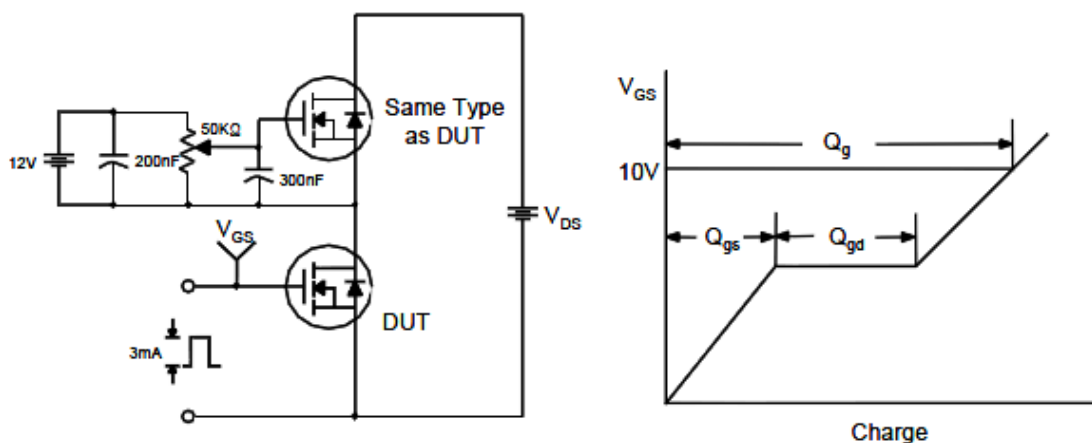


Normalized Thermal Transient Impedance, Junction-to-Case

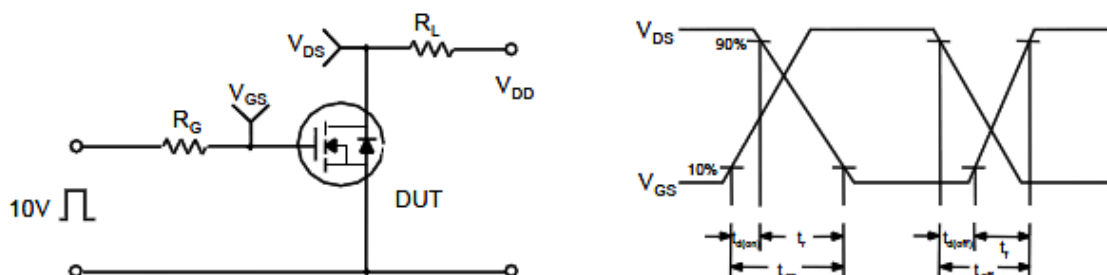


Typical Characteristics

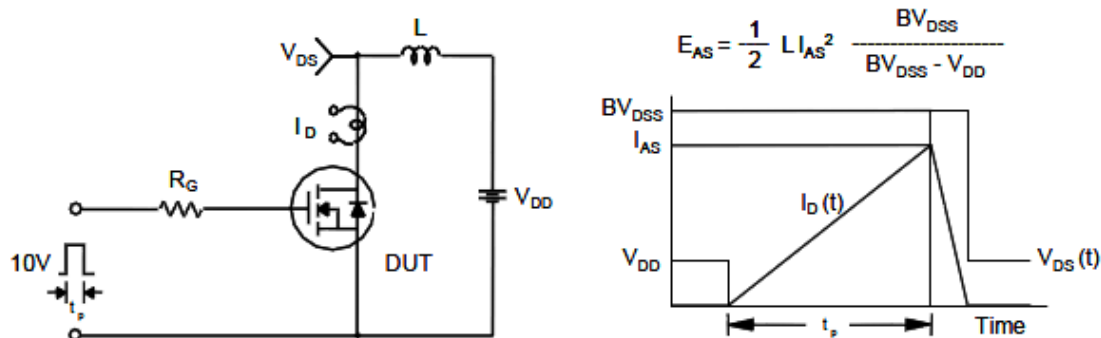
Gate Charge Test Circuit & Waveform



Resistive Switching Test Circuit & Waveforms

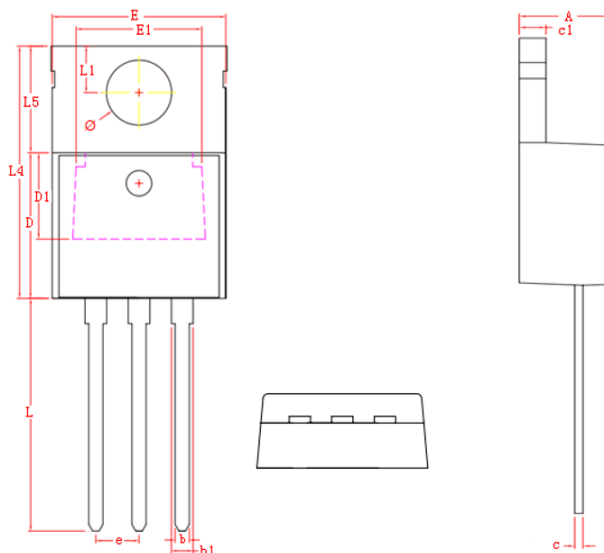


Unclamped Inductive Switching Test Circuit & Waveforms





Package Information (TO-220-3L)



COMMON DIMENSIONS
(UNITS OF MEASURE=MILLIMETER)

SYMBOL	MIN	NOM	MAX
A	4.40	4.60	4.80
b	0.76	0.88	1.00
D	8.60	8.80	9.00
c	0.36	0.43	0.50
E	9.80	10.10	10.40
L4	14.70	15.00	15.30
L5	6.20	6.40	6.60
D1	5.10 REF.		
c1	1.25	1.35	1.45
b1	1.17	1.32	1.47
L	13.25	13.75	14.25
e	2.54 REF.		
L1	2.60	2.75	2.89
Ø	3.71	3.84	3.96
E1	7.40 REF.		

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